### 2SK3047

### Silicon N-Channel Power F-MOS FET

#### Features

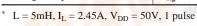
- Avalanche energy capacity guaranteed: EAS > 15mJ
- $\bullet$  V<sub>GSS</sub> =  $\pm 30$ V guaranteed
- $\bullet$  High-speed switching:  $t_f = 25$ ns
- No secondary breakdown

#### ■ Applications

- Contactless relay
- Diving circuit for a solenoid
- Driving circuit for a motor
- Control equipment
- Switching power supply

#### ■ Absolute Maximum Ratings $(T_C = 25^{\circ}C)$

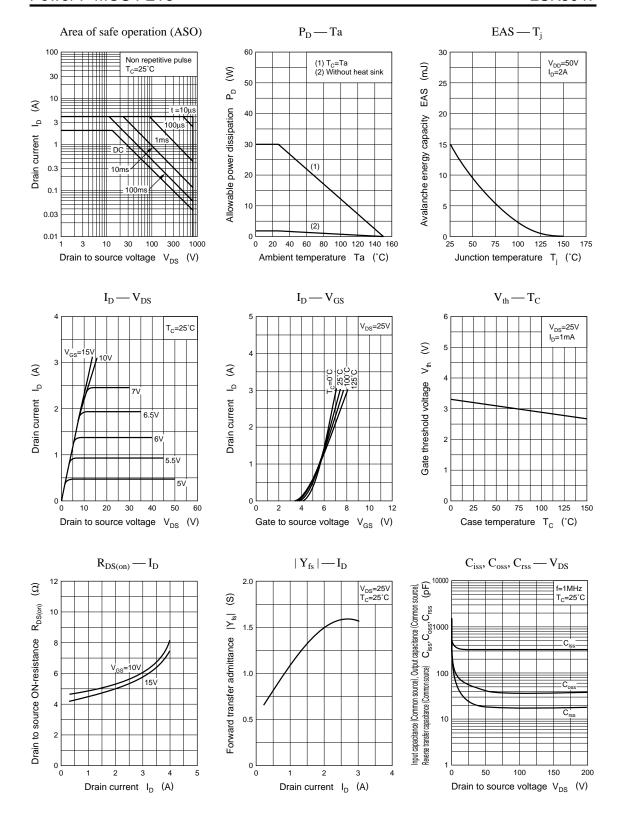
Parameter		Symbol	Ratings	Unit	
Drain to Source breakdown voltage		V <sub>DSS</sub>	800	V	
Gate to Source voltage		V <sub>GSS</sub>	±30	V	
Drain current	DC	$I_D$	±2	A	
	Pulse	$I_{DP}$	±4	A	
Avalanche energy capacity		EAS*	15	mJ	
Allowable power	$T_C = 25^{\circ}C$	D	30	337	
dissipation	Ta = 25°C	$P_{\rm D}$	2	W	
Channel temperature		T <sub>ch</sub>	150	°C	
Storage temperature		$T_{stg}$	-55 to +150	°C	

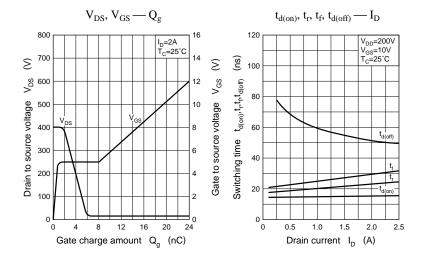


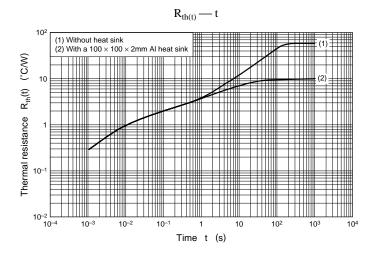
## unit: mm 2.9±0.2 2.6±0.1 0.8±0.1 0.55±0.15 3 5.08±0.5 1: Gate 2: Drain 3: Source TO-220D Package WWW.DZSC

#### ■ Electrical Characteristics ( $T_C = 25$ °C)

Parameter	Symbol	Conditions	min	typ	max	Unit
Drain to Source cut-off current	$I_{DSS}$	$V_{DS} = 640V, V_{GS} = 0$		- T	0.1	mA
Gate to Source leakage current	$I_{GSS}$	$V_{GS} = \pm 30V, V_{DS} = 0$		100	±1	μΑ
Drain to Source breakdown voltage	V <sub>DSS</sub>	$I_D = 1 \text{mA}, V_{GS} = 0$	800			V
Gate threshold voltage	V <sub>th</sub>	$V_{DS} = 25V$ , $I_D = 1mA$	2		5	V
Drain to Source ON-resistance	R <sub>DS(on)</sub>	$V_{GS} = 10V$ , $I_D = 1A$		4.8	7	Ω
Forward transfer admittance	Y <sub>fs</sub>	$V_{DS} = 25V$ , $I_D = 1A$	0.7	1.1		S
Diode forward voltage	V <sub>DSF</sub>	$I_{DR} = 2A, V_{GS} = 0$			-1.3	V
Input capacitance (Common Source)	C <sub>iss</sub>			350		pF
Output capacitance (Common Source)	C <sub>oss</sub>	$V_{DS} = 20V, V_{GS} = 0, f = 1MHz$		60		pF
Reverse transfer capacitance (Common Source)	C <sub>rss</sub>			25		pF
Turn-on time (delay time)	t <sub>d(on)</sub>			15		ns
Rise time DF	t <sub>r</sub>	$V_{GS} = 10V, I_D = 1A$		20		ns
Turn off time (delay time)	$t_{d(off)}$	$V_{DD} = 200V, R_L = 200\Omega$		60		ns
p Ealldimec.com	t <sub>f</sub>			25		ns







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